



Product Specification

DESCRIPTION

The GLF73610 is a family of I_QSmart[™] ultra-efficient, full battery protection ICs with an accurate over charge/discharge voltage, shipping mode, over charge/discharge current, and short circuit protection for lithium-lon/Polymer battery safety.

The over charge and discharge voltage protections keep a rechargeable battery working within the desired safe operating condition. When the battery is charged past the over voltage detection level, the GLF73610 charging switch opens in a preset delay time. As the battery voltage decreases below the over discharge detection voltage level, the GLF73610 discharging switch is turned off immediately to cut off the battery power rail, consuming an ultra-low leakage current (ISD) to save the battery. In addition, when the load current reaches the lsc short circuit protection level, the GLF73610 is turned off and will maintain the off state to avoid any serious damage to system. The short circuit delay time avoids any false trigger which might open the switch.

The GLF73610 provides a shipping mode pin to prevent smart devices with a non-removable battery from discharging during the shipping period. When a charged battery cell is connected the GLF73610 remains in the off state and consumes an ultra-low leakage current (IsD) until the VoN voltage is applied to VOUT pin. Note that the GLF73610 is activated only by a VoN voltage from a charger output.

FEATURES

- Over Charge Detection Voltage, Voc
 - Monitor VOUT to release Voc
 - o Voc high accuracy: ± 0.6 %
- Vod, Over Discharge Detection: 2.80 Vout
- Ioc, Over Charge Current Detection: 330 mA
- I_{OD}, Over Discharge Current Detection: 76 mA
- Short Circuit Protection
- Activated by Applying V_{ON} to the VOUT Pin
- Shipping Mode Implementation
- Low R_{ON}: 62 mΩ Typ. at 3.7 V_{BAT}
- I_Q = 1.48 µA Typ at 3.7 V_{BAT}
- Shutdown Current
 - IsD = 6 nA Typ. at V_{BAT} < V_{OD}
- \circ I_{SD} = 8 nA Typ. at V_{BAT} = 3.7 V, Shipping Mode
- o I_{SD} = 10 nA Typ. at V_{BAT} = 4.2 V, Shipping Mode
- Latch-off at Over Discharge Detection and Short Circuit Protection. Apply Von to VOUT pin to turn on
- 0 V Battery Minimum Voltage for Charging
- Patent Pending Circuit Architecture
- HBM: 8 kV, CDM: 2 kV
- 0.97 mm x 0.97 mm x 0.55 mm Chip Scale Package
 4 Bumps, 0.5 mm Pitch

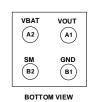
APPLICATIONS

- · BLE Wireless Earphone
- Hearing Aid
- Wearables and Smart IoT Devices

PACKAGE





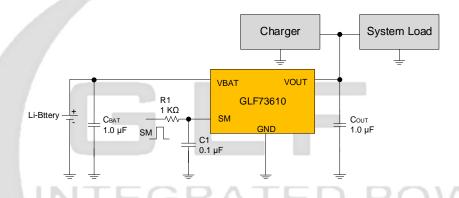


0.97 mm x 0.97 mm x 0.55 mm WLCSP

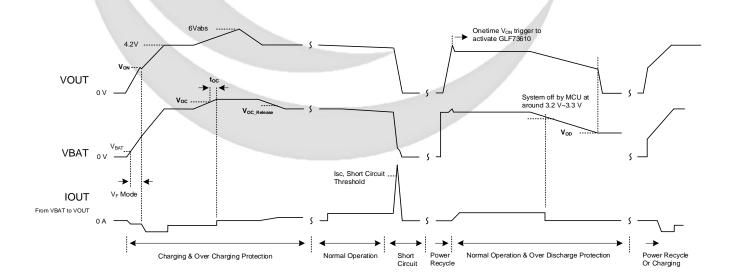
DEVICE INFORMATION

Part Number	Top Mark	Ron (Typ.) V _{BAT} =3.7 V	Over Charge Detection V _{oc}	Over Discharge Detection V _{OD}	Over Charge Current I _{OC}	Over Discharge Current Iod	Short Circuit Current, Isc
GLF73610-DE23C	FD		4.275 V				
GLF73610-CE23C	BY	00 0	4.450 V	2 20 1/	220 4	70 ··· A	050 m A
GLF73610-GE23C	FG	62 mΩ	4.475 V	2.80 V	330 mA	76 mA	250 mA
GLF73610-HE23C	FH		4.525 V				

APPLICATION DIAGRAM



OPERATION DIAGRAM



FUNCTIONAL BLOCK DIAGRAM

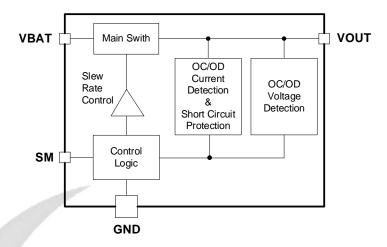


Figure 1. Functional Block Diagram

PIN CONFIGURATION

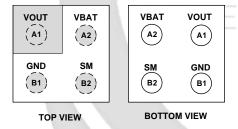


Figure 2. 0.97mm x 0.97mm x 0.55mm WLCSP

PIN DEFINITION

Pin#	Name	Description
A1	VOUT	VOUT pin is connected to the charger output and system load. If the switch is in the off state, applying the appropriate voltage (V_{ON}) to V_{OUT} turns the switch back on.
A2	VBAT	VBAT pin is connected to the positive terminal of a battery pack to monitor the battery voltage. When the V_{BAT} voltage reaches the V_{OD} , the main switch is turned off and maintains the off state to save the battery from discharging.
B1	GND	Ground
B2	SM	Shipping Mode Control. Active high.

ABSOLUTE MAXIMUM RATINGS

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions; extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Pa	Min	Max	Unit	
VBAT, VOUT, SM	Each Pin Voltage Range to GND		- 0.3	6	V
P _D	Power Dissipation at T _A = 25°C		1.2	W	
T _{STG}	Storage Junction Temperature	- 65	150	°C	
T _A	Operating Temperature Range	- 40	85	°C	
Өја	Thermal Resistance, Junction to Ambi		85	°C/W	
ESD	ESD Electrostatic Discharge Capability Human Body Model, JESD22-A114		8		ls\/
ESD	Electiostatic Discharge Capability	Charged Device Model, JESD22-C101	2		kV

ELECTRICAL CHARACTERISTICS

Values are at $V_{BAT} = 3.6 \text{ V}$, $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter	Conditions			Тур	Max	Units	
		GLF73610-DE23C	V _{BAT} increases until switch turns off	4.250	4.275	4.300		
			Ta= 55 °C ⁽¹⁾		4.268			
		GLF73610-CE23C	V _{BAT} increases until switch turns off	4.425	4.450	4.475		
V 1	Composition Valled Data disc	GRAT	Ta= 55 °C ⁽¹⁾	D V	4.444	R	V	
Voc	Over Charge Voltage Detection	GLF73610-GE23C	V _{BAT} increases until switch turns off	4.450	4.475	4.500	V	
			Ta= 55 °C ⁽¹⁾		4.471			
		GLF73610-HE23C	V _{BAT} increases until switch turns off	4.500	4.525	4.550		
1		01. 100.0 1.1200	Ta= 55 °C ⁽¹⁾	/	4.520			
Voc_hys	Over Charge Voltage Protection Release Hysteresis	V _{BAT} decreases and s	witch turns on		150		mV	
tvoc	Over Charge Voltage Protection Delay Time	V _{BAT} > V _{OC} , Blanking time until switch turns off			560		ms	
V _{OD}	Over Discharge Voltage Detection	V _{BAT} decreases until switch turns off			2.80	2.90	V	
VOD	Over Discharge voltage Detection	Ta=55 °C ⁽¹⁾			2.79		V	
V _{OD_HYS}	Over Discharge Voltage Protection Release Hysteresis	V _{BAT} increases and sv	vitch turns on		150		mV	
tvod	Over Discharge Voltage Protection Delay Time	V _{BAT} < V _{OD} , Blanking	time until switch turns off		40		ms	
V _{ON} ⁽¹⁾	ON Voltage applied to VOUT to turn	Vout to turn on switch	, $V_{BAT} \geq 3.1 V$		3.6		V	
VON \ /	on switch	Ta= 55 °C			3.6		v	
loc	Over Charge Current Detection			260	330	400	mA	
tıoc	Over Charge Current Detection Delay Time				40		ms	
I _{OD}	Over Discharge Current Detection			50	76	98	mA	
t _{IOD}	Over Discharge Current Detection Delay Time				20		ms	
Isc	Short Circuit Current Detection				250		mA	
tsc	Short Circuit Delay Time				400		μs	
Iq	Quiescent Current with Switch On	$V_{BAT} = 3.7 \text{ V}, I_{OUT} = 0 \text{ r}$			1.48		μA	
_ ~		$V_{BAT} = 4.2 \text{ V}, I_{OUT} = 0 \text{ r}$		1.55				



		V _{BAT} = 4.2 V, I _{OUT} = 0 mA, S Ta= 55°C ⁽¹⁾	Switch = ON		1.66			
		V _{BAT} = 4.2 V, V _{OUT} = 0 V, S	hipping Mode		10			
I _{SD}	Shutdown Current from VBAT	$V_{BAT} = 3.7 \text{ V}, V_{OUT} = 0 \text{ V}, \text{ S}$	hipping Mode		8		nA	
130	When Main Switch is Off	$V_{BAT} = 2.5 \text{ V}, V_{OUT} = 0 \text{ V}$			6		.,,	
Í		$V_{BAT} = 2.5 \text{ V}, V_{OUT} = 0 \text{ V}, T_{a}$	a=55 °C ⁽¹⁾		8			
1		V _{BAT} = 4.2 V. I _{OUT} = 40 mA	Ta= 25 °C		58			
		VBAT- 4.2 V, IOUT- 40 IIIA	Ta= 55 °C (1)		62			
Ron	On-Resistance	V _{BAT} = 3.7 V. lout= 40 mA	Ta= 25 °C		62		mΩ	
		VBAT- 3.7 V, 10UT- 40 IIIA	Ta= 55 °C ⁽¹⁾		66			
		V _{BAT} = 3.3 V, I _{OUT} = 40 mA	Ta= 25 °C		67			
toff (1)	Turn-Off Time	C _{OUT} = 1.0 μF, R _{OUT} = 150 Ω	Ω , $V_{OUT} = V_{OD}$ to 0 V		340		μs	
VsM	SM Input Logic High Voltage	V _{BAT} = 2.5 V to 5.5 V		1.2			V	
tsм	SM pulse width	V _{BAT} = 3.3 V to 4.2 V			20		ms	
tdsм	Shipping Mode Delay	V _{BAT} = 3.3 V to 4.2 V			610	650	ms	
Rsm	SM pull down resistance	Internal Resistance	Internal Resistance				kΩ	

Notes: 1. By design; characterized, not production tested.

2. All values of delay timing were characterized but not tested in production.

TYPICAL PERFORMANCE CHARACTERISTICS

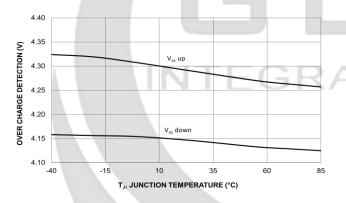


Figure 3. Over Charge Voltage Detection vs. Temperature, GLF73610-DE23C

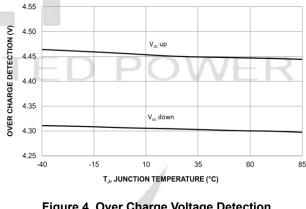


Figure 4. Over Charge Voltage Detection vs. Temperature, GLF73610-CE23C

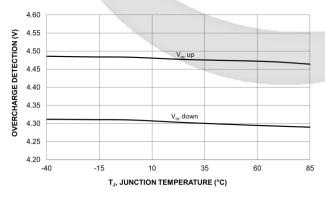


Figure 5. Over Charge Voltage Detection vs. Temperature, GLF73610-GE23C

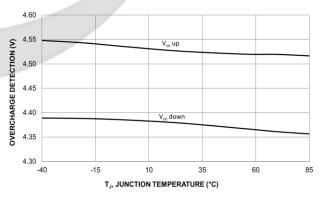


Figure 6. Over Charge Voltage Detection vs. Temperature, GLF73610-HE23C

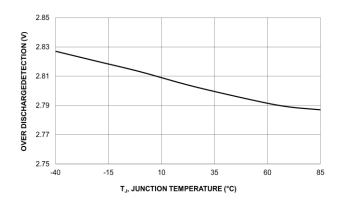
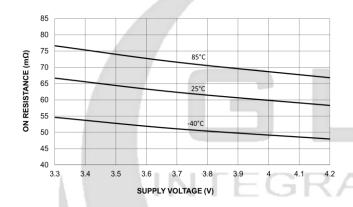


Figure 7. Over Discharge Voltage Detection vs. Temperature

Figure 8. Over Discharge Voltage Detection Release Hysteresis vs. Temperature



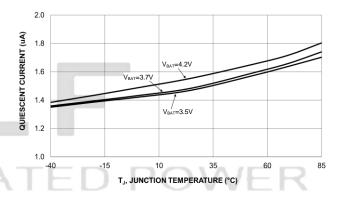


Figure 9. On-Resistance vs. Supply Voltage

Figure 10. Quiescent Current vs. Temperature

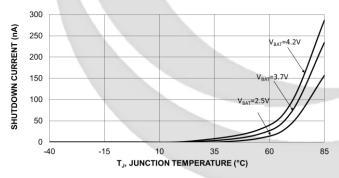


Figure 11. Shutdown Current vs. Temperature

APPLICATION INFORMATION

The GLF73610 is an I_QSmart[™] ultra-efficient battery protection IC with the accurate over charge voltage, shipping mode, over charge current, and short circuit protection for lithium-lon/ Polymer battery safety. The best-in-class efficiency makes it ideal for the design of hearing devices, wearable devices, and tiny IoT devices.

Charging Activation and 0 V Battery Charging

The GLF73610 is activated to turn on the main charging switch only by applying the on voltage (VoN) to the VOUT pin, when a charger IC is enabled. The minimum battery voltage to charge is 0 V. With a deeply discharged battery, the GLF73610 does not turn on both the charge and discharge path and the pre-charge current flows through an internal diode until the battery voltage reaches the over discharge voltage detection level (VoD). The GLF73610 provides a hiccup charging mode when the charge mode changes from the pre-charge to the constant current charge mode. The main switch of the GLF73610 turns on and off in 60 ms period and pulse current charges the battery until the charge mode is completely transferred to the constant current mode. As the battery voltage increases beyond the over discharge voltage detection, the charge and discharge path switches will be fully activated to reduce the voltage drop and save power dissipation during both constant-current and constant-voltage charging modes.

Over Charging and Discharging Voltage Protection

When the voltage of a battery increases to the over-charge voltage detection level (V_{OC}), the charge path is turned off to stop charging the battery after a preset over-charge detection delay time (t_{OC}) in order to avoid a false trigger. The charging path is turned on again when the VOUT voltage falls by 150 mV. The charging path is not turned off if the battery voltage returns to a voltage less than the detection level within the delay time. The charging path turns on again as the battery voltage decreases below the over-charge release voltage level (V_{OC} – V_{OC_HYS}). When the voltage of a battery decreases to the over-discharge detection voltage level, the GLF73610 discharging path is turned off consuming an ultra-low leakage current to save the battery. The GLF73610 remains in the off state until a higher voltage is applied to the VOUT pin.

Over Charging and Discharging Current, Short Circuit Protection

If an over-charging current is detected during the constant current charging mode, the GLF73610 will shut off the charging path in a preset detection delay time. When the over-discharging current condition occurs for the detection delay(t_{IOD}), the discharge path turns off. During the operation, if the discharge current from the battery exceeds the short circuit detection level (I_{SC}), the discharging path will be turned off after a preset delay time (t_{SC}) in order to avoid a false detection. After the short circuit protection event, the GLF73610 maintains in the off state and needs a power recycle of a system to apply V_{ON} to VOUT pin in order to be reactivated.

Shipping Mode

The GLF73610 provides system designers with the SM pin to turn off safely both discharging and charging path to prevent a pre-charged battery capacity from discharging at all. During the shipping mode when the GLF73610 is completely off, it consumes an ultra-low current to maintain the battery capacity. The GLF73610 is activated again by applying VoN to the VOUT pin when a charger is applied. An RC filter circuit can be added in front of SM to prevent interference when the shipping mode is not enabled.

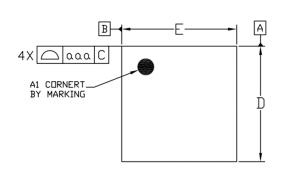
Input and Output Capacitors

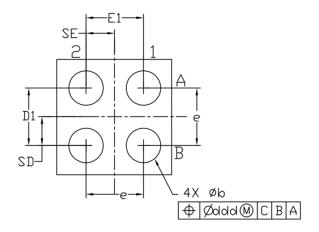
Input and output capacitors are not required for GLF73610 operation. However, a 1.0µF capacitor is recommended to be placed close to the VBAT and VOUT pins in order to mitigate any unexpected electrical noise or the transient voltage peak caused by a hot-plugging voltage source.

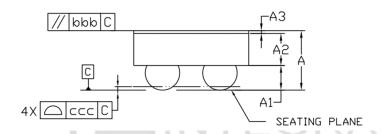
Board Layout

All traces should be as short as possible to minimize parasitic inductance effects. Wide traces for VBAT, VOUT, and GND will help reduce voltage drops, and parasitic effects during dynamic operation as well as improve the thermal performance at high load currents.

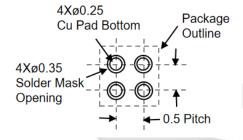
PACKAGE OUTLINE







Recommended Footprint



Dimensional Ref.								
Min.	Nom.	Max.						
0.500	0.550	0.600						
0.225	0.250	0.275						
0.255	0.275	0.300						
0.020	0.025	0.030						
0.960	0.970	0.985						
0.960	0.970	0.985						
0.450	0.500	0.550						
0.450	0.500	0.550						
0.260	0.310	0.360						
0	.500 BS	С						
0	.250 BS	С						
0	.250 BS	С						
ol. of Form&Position								
0.10								
0.10								
0.05								
	0.05							
	Min. 0.500 0.225 0.255 0.020 0.960 0.450 0.260 0	Min. Nom. 0.500 0.550 0.225 0.250 0.225 0.275 0.020 0.025 0.960 0.970 0.960 0.970 0.450 0.500 0.260 0.310 0.500 BS 0.250 BS 0.250 BS ol. of Form&Pos						

PACKAGING INFORMATION

Part Number	Package	Pins	Pitch	Top Mark	Moisture Sensitivity Level	Environmental Information
GLF73610-DE23C				FD		
GLF73610-CE23C	0.97 mm x 0.97 mm x 0.55 mm	4	0 Emm	BY	MCI 1	ROHS+HF
GLF73610-GE23C	WLCSP	4	0.5mm	FG	MSL1	KUNS+NF
GLF73610-HE23C				FH		

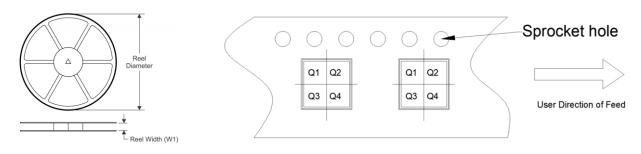
Notes

- 1. ALL DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES)
- 2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.
- 3. A3: BACKSIDE LAMINATION

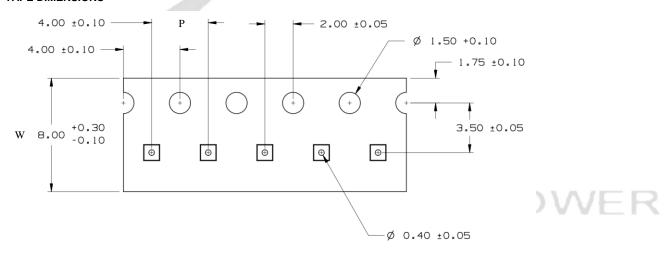
TAPE AND REEL INFORMATION

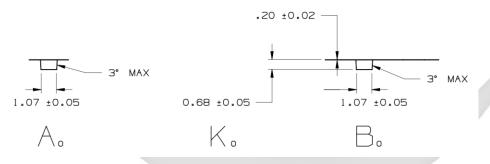
REEL DIMENSIONS

QUADRANT ASSIGNMENTS PIN 1 ORIENTATION TAPE



TAPE DIMENSIONS





Device	Package	Pins	SPQ	Reel Diameter (mm)	Reel Width W1	Α0	В0	K0	Р	w	Pin1
GLF73610	WLCSP	4	3000	180	9	1.07	1.07	0.68	4	8	Q1

Remark:

- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- C0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P: Pitch between successive cavity centers

SPECIFICATION DEFINITIONS

Document Type	Meaning	Product Status
Target Specification	This is a target specification intended to support exploration and discussion of critical needs for a proposed or target device. Spec limits including typical, minimum, and maximum values are desired, or target, limits. GLF reserves the right to change limits at any time without warning or notification. A target specification in no way guarantees future production of the device in question.	Design / Development
Preliminary Specification	' I change the checitication at any time without warning or notification A	
Product Specification	This document represents the anticipated production performance characteristics of the device.	Production

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